DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION DOCKET NO. MEGO1-013

As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if phural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Thin Film Semiconductor Package And Method Of Fabrication

he specification of which (check one)		·	
X is attached hereto.			
was filed on			
Application Serial No.			
and was amended on(if	continuite)		
I hereby state that I have reviewed and amonded by any amendment referred to	above.	we Identified specification including the claims, a	.s
I acknowledge the duty to disclose info 37 Code of Federal Regulations, §1.56	rmation which is material to the estate	camination of this application in accordance with	Title
a tiling date defore that of the appread	under Title 35, United States Codnave also identified below any fore on on which priority is claimed:	s §119 of any foreign application(s) for patent or ign application for patent or inventor's certificate	having
Prior Foreign Application(s)		Priority Claimed:	
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
(Application Serial No.)	(Filing Date) (Status)	(patented, pending, abandoned)	vn and
defined in Title 37, Code of Federal R national or PCT international filing da (Application Serial No.)	egulations, §1.56(a) which occurre te of this application: (Filing Date) (Status)	y United States application(s) listed below and, in seed in the prior United States application in the nacknowledge the duty to disclose material informated between the filing date of the prior application (patented, pending, abandoned)	and the
the like so made are punishable by fine that such willful false statements may	e or imprisonment, or both, under jeopardize the validity of the appli	Section 1001 of Title 18 of the United States Contains or any patent issued thereon.	de and
annication and tennence all Distincts if	THE PAICH AND LIQUENTIA CENTER	ollowing attorney(s) and/or agent(s) to prosecute connected therewith. (list name & registration no	.)
GEORGE O. SAILE. (Reg. N	No. 19,572), STEPHEN B. A	CKERMAN (Reg. No. 37,761)	
Send Correspondence to: 20 MCINT	OSH DRIVE, POUGHKEEPSIE	NEW YORK 12603	
Direct telephone Calls to: (name & tele	_t_u_ www.han) GEORGEO SAI	LE NEW YORK 845 452 5805	
MOU-SHIUNG LIN Full name of sole or first inventor Inventor's substitute		1/18/2002 Date	
28 Ginsan Joth St.	Isinchu, Tariwan		
Citizenship			
21 R&D First Road, Science-B	ased Industrial Park, Hsin-Chu.	Taiwan, Republic of China	

DOCKET NO. MEG01-013

JIN-YUAN LEE	
Full name of second inventor	Date
Jin-Yuan Loa Inventor's signature	18/02
Inventor's signature	
No. 11 Lane 4, An-HO Street MSIN-CALL City Taiwan	
Inventor's signature No.11 Lane 4, An-Ho Street Hsin-Chu City Taiwan Residence Republic of China, Jaiwan Crizenship	
Crizenship	
21 R&D First Road, Science Based Industrial Park, Hsin-Chu, Tair Post Office Address	wan, Republic of China
CHING-CHENG HUANG Full name of third inventor	Date
China - Clara Hugar	1/2/02
Ching-Cheng Loury	2/0 -
117-1, No. 38-24, Kuanghua = th street. Residence	Hsin-Chu City, Taiwan
Republic of china, Taiwan	
Citizenship	
2) R&D First Road, Science-Based Industrial Park, Hsin-Chu, Tai Post Office Address	wan, Republic of China
Full name of fourth inventor	Date
rui name of fourth inventor	
Inventor's signature	
Residence	•
Citizenship	,
Post Office Address	
Full name of fifth inventor	Daie
Inventor's signature	
Residence	
Citizenship	
Post Office Address	
	•
Full name of sixth inventor	Date
Inventor's signature	
Residence	44-10-00-00-00-00-00-00-00-00-00-00-00-00-
Citizenship	
Post Office Address	